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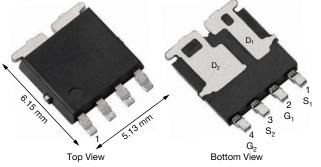


Vishay Siliconix

Automotive Dual N-Channel 12 V (D-S) 175 °C MOSFETs

PRODUCT SUMMARY					
	N-CHANNEL 1	N-CHANNEL 2			
V _{DS} (V)	12	12			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 V$	0.0065	0.0033			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 V$	0.0093	0.0045			
I _D (A)	20	60			
Configuration	Dua	al N			
Package	PowerPAK [®] SO-8	Dual Asymmetric			

PowerPAK[®] SO-8L Dual Asymmetric



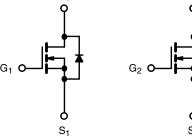
FEATURES

- TrenchFET[®] power MOSFET
- AEC-Q101 qualified ^d
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

D



RoHS COMPLIANT HALOGEN FREE



N-Channel 1 MOSFET

S₂ N-Channel 2 MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unless	s otherwise r	oted)			
PARAMETER		SYMBOL	N-CHANNEL 1	N-CHANNEL 2	UNIT	
Drain-Source Voltage		V _{DS}	12	12	V	
Gate-Source Voltage		V _{GS}	± 20		v	
Continuous Drain Current ^a	T _C = 25 °C		20	60		
	T _C = 125 °C	I _D	20	60		
Continuous Source Current (Diode Conduction)		I _S	20 ^a	44	A	
Pulsed Drain Current ^b		I _{DM}	80	180		
Single Pulse Avalanche Current			18	18		
Single Pulse Avalanche Energy	L = 0.1 mH		16.2	16.2	mJ	
Maximum Power Dissigation ^b	T _C = 25 °C		27	48	w	
Maximum Power Dissipation -	T _C = 125 °C	P _D	9		vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175		℃	
Soldering Recommendations (Peak Temperature) e,	f		20	60		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	N-CHANNEL 1	N-CHANNEL 2	UNIT
Junction-to-Ambient	PCB Mount ^c	R _{thJA}	85	85	°C/W
Junction-to-Case (Drain)		R _{thJC}	5.5	3.1	C/W

Notes

- a. Package limited.
- b. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- c. When mounted on 1" square PCB (FR4 material).
- d. Parametric verification ongoing.
- e. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- f. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

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PARAMETER	SYMBOL	TEST CONDITIONS				TYP.	MAX.	UNI	
Static							1	<u> </u>	
	.,	V _{GS} =	= 0 V, I _D = 250 μA	N-Ch 1	12	-	-		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	V _{GS} = 0 V, I _D = 250 μA		12	-	-	.,	
		V _{DS} =	N-Ch 1	1	1.5	2	V		
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	N-Ch 2	1	1.5	2		
Cata Sauraa Laakaga	-	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		N-Ch 1	-	-	± 100		
Gate-Source Leakage	I _{GSS}	v _{DS} =	$0 v, v_{GS} = \pm 20 v$	N-Ch 2	-	-	± 100	nA	
		$V_{GS} = 0 V$	V _{DS} = 12 V	N-Ch 1	-	-	1		
		$V_{GS} = 0 V$	V _{DS} = 12 V	N-Ch 2	-	-	1		
Zene Oate Maltage Dueie Ormant		$V_{GS} = 0 V$	V _{DS} = 12 V, T _J = 125 °C	N-Ch 1	-	-	50		
Zero Gate Voltage Drain Current	IDSS	$V_{GS} = 0 V$	V _{DS} = 12 V, T _J = 125 °C	N-Ch 2	-	-	50	μA	
		$V_{GS} = 0 V$	V _{DS} = 12 V, T _J = 175 °C	N-Ch 1	-	-	500		
		$V_{GS} = 0 V$	V _{DS} = 12 V, T _J = 175 °C	N-Ch 2	-	-	500		
On State Duain Command 2		$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	N-Ch 1	20	-	-		
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	N-Ch 2	30	-	-	A	
		V _{GS} = 10 V	I _D = 15 A	N-Ch 1	-	0.0052	0.0065		
		V _{GS} = 10 V	I _D = 20 A	N-Ch 2	-	0.0025	0.0033		
	R _{DS(on)}	V _{GS} = 10 V	I _D = 15 A, T _J = 125 °C	N-Ch 1	-	0.0075	-	Ω	
		V _{GS} = 10 V	I _D = 20 A, T _J = 125 °C	N-Ch 2	-	0.0031	-		
Drain-Source On-State Resistance ^a		V _{GS} = 10 V	I _D = 15 A, T _J = 175 °C	N-Ch 1	-	0.0085	-		
		V _{GS} = 10 V	I _D = 20 A, T _J = 175 °C	N-Ch 2	-	0.0038	-		
		$V_{GS} = 4.5 V$	I _D = 13 A	N-Ch 1	-	0.0075	0.0093		
		$V_{GS} = 4.5 V$	I _D = 18 A	N-Ch 2	-	0.0034	0.0045	45	
F		V _{DS}	= 10 V, I _D = 15 A	N-Ch 1	-	49	-	_	
Forward Transconductance ^b	9 _{fs}	V _{DS}	= 10 V, I _D = 20 A	N-Ch 2	-	91	-	S	
Dynamic ^b							•		
	0	$V_{GS} = 0 V$	V _{DS} = 6 V, f = 1 MHz	N-Ch 1	-	777	975		
Input Capacitance	C _{iss}	$V_{GS} = 0 V$	V _{DS} = 6 V, f = 1 MHz	N-Ch 2	-	2018	2525		
	0	$V_{GS} = 0 V$	V _{DS} = 6 V, f = 1 MHz	N-Ch 1	-	539	675		
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	V _{DS} = 6 V, f = 1 MHz	N-Ch 2	-	1313	1645	pF	
	0	$V_{GS} = 0 V$	V _{DS} = 6 V, f = 1 MHz	N-Ch 1	-	270	340		
Reverse Transfer Capacitance	C _{rss}	$V_{GS} = 0 V$	V _{DS} = 6 V, f = 1 MHz	N-Ch 2	-	683	855		
	<u> </u>	$V_{GS} = 10 V$	$V_{DS} = 6 V, I_{D} = 20 A$	N-Ch 1	-	14.5	22		
Total Gate Charge ^c	Qg	$V_{GS} = 10 V$	$V_{DS} = 6 V, I_D = 60 A$	N-Ch 2	-	35.9	54		
Cata Sauraa Charga C	0	$V_{GS} = 10 V$	$V_{DS} = 6 V, I_{D} = 20 A$	N-Ch 1	-	1.7	-	nC	
Gate-Source Charge ^c	Q _{gs}	V _{GS} = 10 V	$V_{DS} = 6 V, I_{D} = 60 A$	N-Ch 2	-	4.1	-	1	
Cata Duain Charge C	0	V _{GS} = 10 V	$V_{DS} = 6 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	N-Ch 1	-	2.1	-		
Gate-Drain Charge ^c	Q_{gd}	V _{GS} = 10 V	$V_{DS} = 6 \text{ V}, \text{ I}_{D} = 60 \text{ A}$	N-Ch 2	-	4.3	-		
Cata Dasistanas			1		1.3	2.6	4	~	
Gate Resistance	R_g		f = 1 MHz	N-Ch 2	0.5	1.1	1.7	Ω	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

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SPECIFICATIONS (T _C =	= 25 °C, unless of	therwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
		$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 6 \ V, \ R_{\text{L}} = 0.3 \ \Omega \\ I_{\text{D}} \cong 20 \ A, \ V_{\text{GEN}} = 10 \ V, \ R_{\text{g}} = 1 \ \Omega \end{array}$	N-Ch 1	-	8.8	13.5		
Turn-On Delay Time ^c	t _{d(on)} –	$\label{eq:VDD} \begin{array}{l} V_{DD} = 6 \ V, \ R_L = 0.1 \ \Omega \\ I_D \cong 60 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$	N-Ch 2	-	10.7	16.5		
		$\label{eq:VDD} \begin{array}{l} V_{DD} = 6 \ V, \ R_L = 0.3 \ \Omega \\ I_D \cong 20 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$	N-Ch 1	-	3.2	5		
Rise Time ^c	t _r –	$\label{eq:VDD} \begin{array}{l} V_{DD} = 6 \ V, \ R_L = 0.1 \ \Omega \\ I_D \cong 60 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$	N-Ch 2	-	4.5	7		
		$\label{eq:VDD} \begin{array}{l} V_{DD} = 6 \ V, \ R_L = 0.3 \ \Omega \\ I_D \cong 20 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$	N-Ch 1	-	20	30	ns	
Turn-Off Delay Time ^c	t _{d(off)} –	$\label{eq:VDD} \begin{array}{l} V_{DD} = 6 \ V, \ R_L = 0.1 \ \Omega \\ I_D \cong 60 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$	N-Ch 2	-	28	42		
Fall Time ^c	+.	$\label{eq:VDD} \begin{array}{l} V_{DD} = 6 \ V, \ R_L = 0.3 \ \Omega \\ I_D \cong 20 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$	N-Ch 1	-	2.6	4	-	
	t _f	$\label{eq:VDD} \begin{array}{l} V_{DD} = 6 \ V, \ R_L = 0.1 \ \Omega \\ I_D \cong 60 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$	N-Ch 2	-	5	8		
Source-Drain Diode Ratings a	and Characteristics	b						
Pulsed Current ^a	leu		N-Ch 1	-	-	80	^	
	I _{SM}		N-Ch 2	-	- 80 - 180 A	A		
Forward Valtage	M	$I_F = 10 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	N-Ch 1	-	0.8 1.2	v		
Forward Voltage	V _{SD} -	$I_F = 20 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	N-Ch 2	-	0.8	1.2	v	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

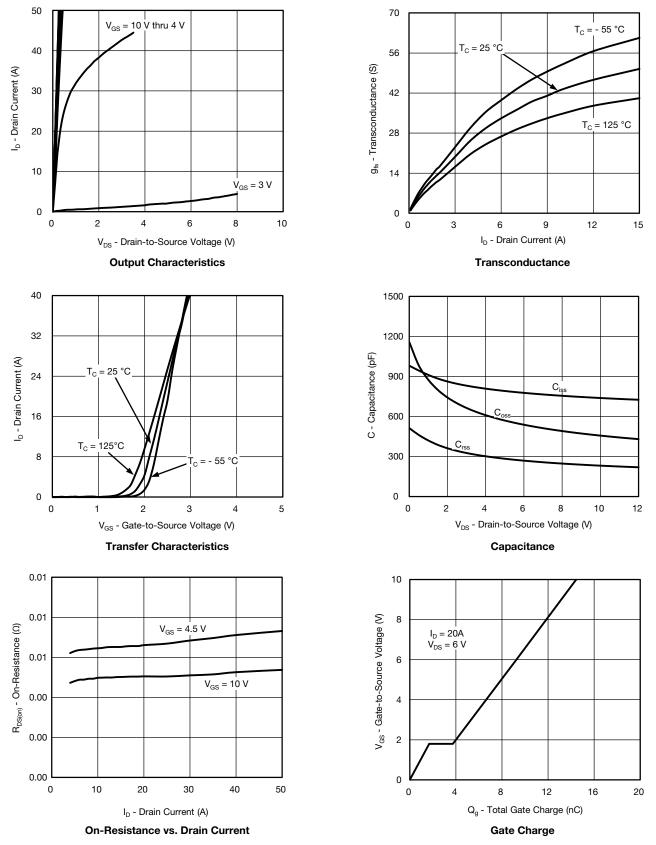
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

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N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



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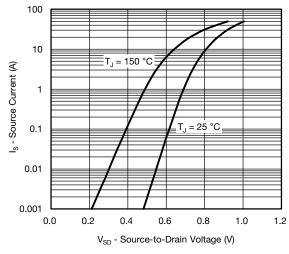
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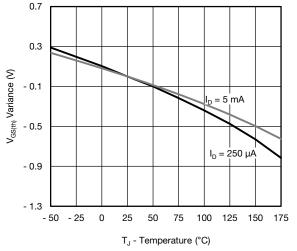
N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



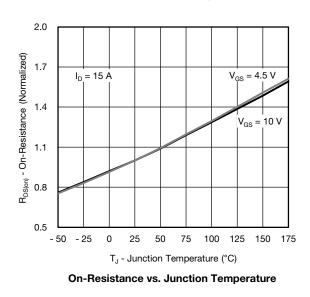
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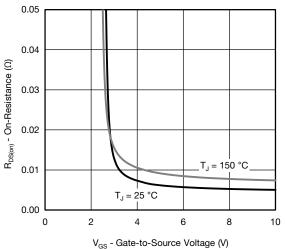
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Source Drain Diode Forward Voltage

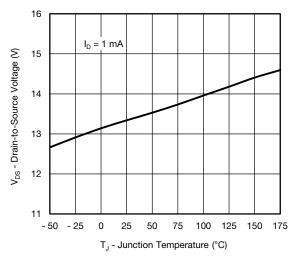




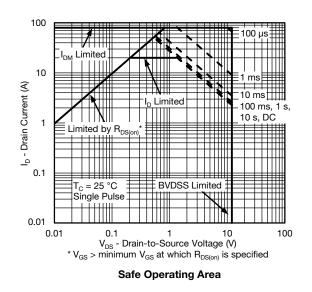




On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature



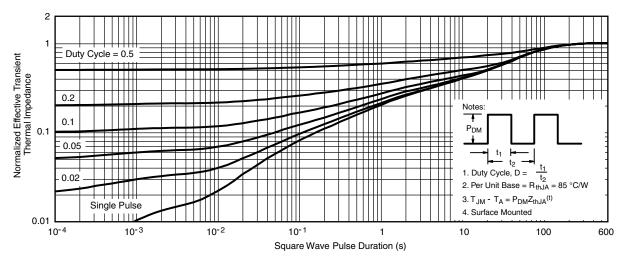
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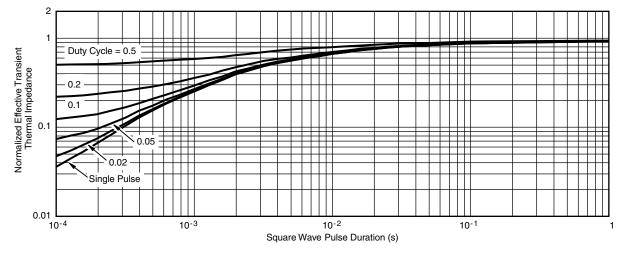
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N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient





Note

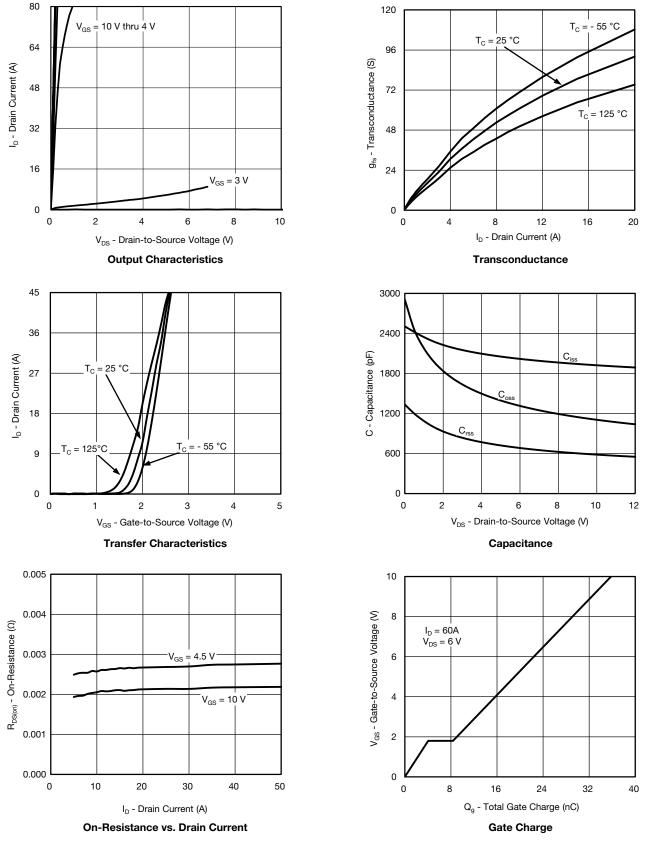
The characteristics shown in the graph:

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

is given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



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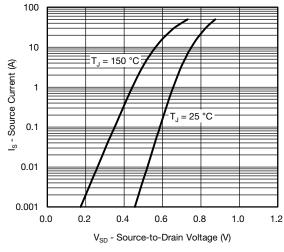
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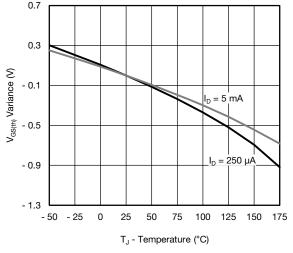


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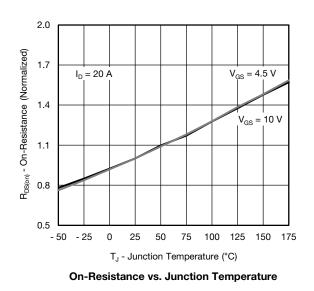
N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

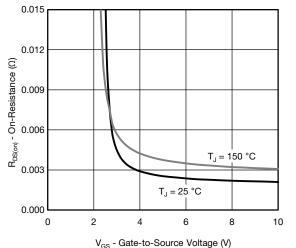


Source Drain Diode Forward Voltage

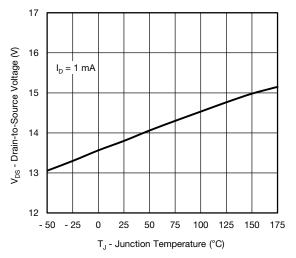


Threshold Voltage

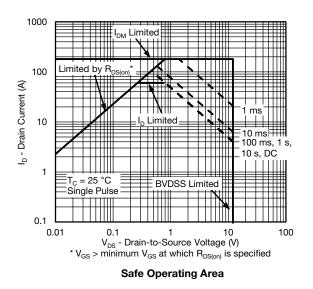




On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature

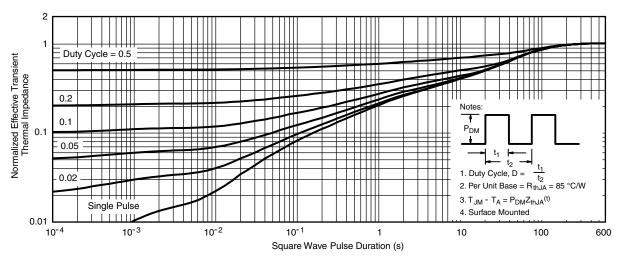


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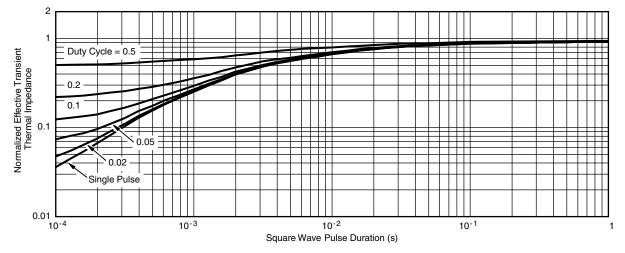
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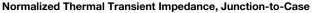


N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient





Note

• The characteristics shown in the graph:

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

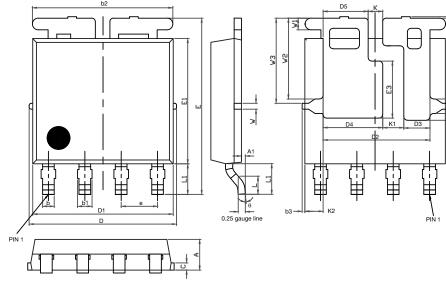
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PowerPAK[®] SO-8L Assymetric Case Outline



DIM.		MILLIMETERS		INCHES			
DINI.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	0.06	0.13	0.000	0.003	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3	0.04	0.12	0.20	0.002	0.005	0.008	
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.63	3.73	3.83	0.143	0.147	0.151	
D3	0.81	0.91	1.01	0.032	0.036	0.040	
D4	1.98	2.08	2.18	0.078	0.082	0.086	
D5	1.47	1.57	1.67	0.058	0.062	0.066	
е	1.20	1.27	1.34	0.047	0.050	0.053	
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
E3	1.89	1.99	2.09	0.074	0.078	0.082	
F	0.05	0.12	0.19	0.002	0.005	0.007	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
К	0.41	0.51	0.61	0.016	0.020	0.024	
K1	0.64	0.74	0.84	0.025	0.029	0.033	
K2	0.54	0.64	0.74	0.021	0.025	0.029	
W	0.13	0.23	0.33	0.005	0.009	0.013	
W1	0.31	0.41	0.51	0.012	0.016	0.020	
W2	2.72	2.82	2.92	0.107	0.111	0.115	
W3	2.86	2.96	3.06	0.113	0.117	0.120	
W4	0.41	0.51	0.61	0.016	0.020	0.024	
θ	5°	10°	12°	5°	10°	12°	

DWG: 6009

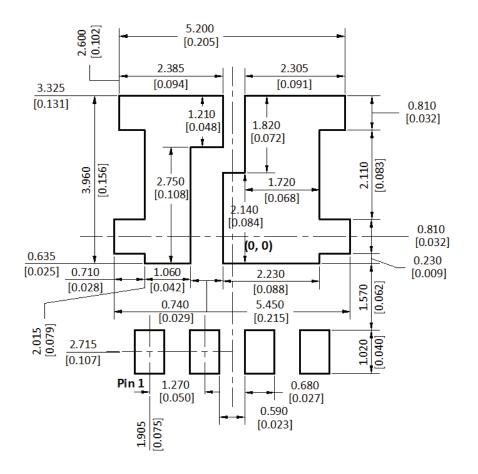
Note

• Millimeters will govern

C14-0057-Rev. D, 07-Apr-14



RECOMMENDED MINIMUM PADs FOR PowerPAK® SO-8L DUAL ASYMMETRIC



Recommended Minimum Pads Dimensions in mm [inches]



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